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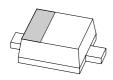
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Kind regards,

Team Nexperia



Unidirectional ESD protection for transient voltage suppression

Rev. 01 — 3 June 2009

Product data sheet

1. Product profile

1.1 General description

Unidirectional ElectroStatic Discharge (ESD) protection diodes in a very small Surface-Mounted Device (SMD) plastic package designed to protect one signal line from the damage caused by ESD and transient overvoltage.

Table 1. Product overview

Type number	Package		Configuration
	NXP	JEITA	
PESD5V0S1UJ	SOD323F	SC-90	single
PESD12VS1UJ			

1.2 Features

- Transient Voltage Suppression (TVS) protection of one line
- Max. peak pulse power: P_{PP} = 890 W
- Low clamping voltage: V_{CL} = 19 V
- Low leakage current: I_{RM} = 300 nA
- ESD protection up to 30 kV
- IEC 61000-4-2; level 4 (ESD)
- IEC 61000-4-5 (surge); I_{PP} = 47 A
- AEC-Q101 qualified

1.3 Applications

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- Communication systems
- Portable electronics
- Medical and industrial equipment

1.4 Quick reference data

Table 2. Quick reference data

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{RWM}	reverse standoff voltage					
	PESD5V0S1UJ		-	-	5	V
	PESD12VS1UJ		-	-	12	V
C_d	diode capacitance	$f = 1 MHz; V_R = 0 V$				
	PESD5V0S1UJ		-	480	530	pF
	PESD12VS1UJ		-	160	180	pF



Unidirectional ESD protection for transient voltage suppression

Pinning information 2.

Tal	ole	3.	Р	in	ni	no

	•		
Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	
2	anode	1 2	1 2 006aaa152

^[1] The marking bar indicates the cathode.

Ordering information 3.

Table 4. **Ordering information**

Type number	Package	Package				
	Name	Description	Version			
PESD5V0S1UJ	SC-90	plastic surface-mounted package; 2 leads	SOD323F			
PESD12VS1UJ						

Marking 4.

Product data sheet

Table 5. Marking codes

•	
Type number	Marking code
PESD5V0S1UJ	1Q
PESD12VS1UJ	1R

Limiting values 5.

Table 6. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
P_{PP}	peak pulse power	$t_p = 8/20 \; \mu s$	[1][2]		
	PESD5V0S1UJ		-	890	W
	PESD12VS1UJ		-	600	W
I_{PP}	peak pulse current	$t_p = 8/20 \ \mu s$	[1][2]		
	PESD5V0S1UJ		-	47	Α
	PESD12VS1UJ		-	22.5	Α

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Product data sheet

PESD5V0S1UJ; PESD12VS1UJ

Unidirectional ESD protection for transient voltage suppression

Limiting values ...continued Table 6.

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	[3] _	420	mW
			<u>[4]</u> _	720	mW
Tj	junction temperature		-	150	°C
T_{amb}	ambient temperature		–55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

- [1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.
- [2] Soldering point of cathode tab.
- Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

ESD maximum ratings Table 7.

T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Max	Unit
	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	<u>[1]</u>	-	30	kV
	machine model		-	400	V	
	MIL-STD-883 (human body model)		-	16	kV	

^[1] Device stressed with ten non-repetitive ESD pulses.

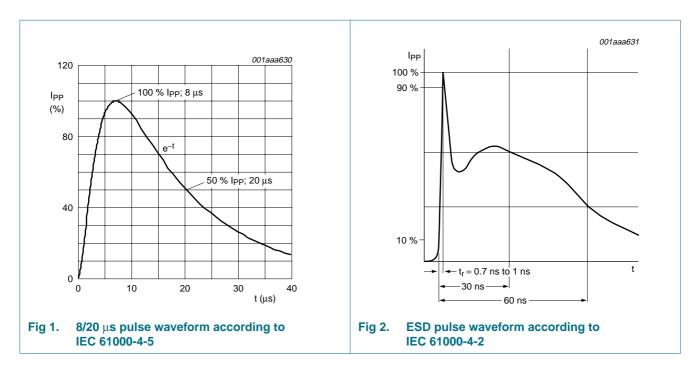
Table 8. **ESD** standards compliance

Standard	Conditions
IEC 61000-4-2; level 4 (ESD)	> 15 kV (air); > 8 kV (contact)
MIL-STD-883; class 3 (human body model)	> 4 kV

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6. Thermal characteristics

Product data sheet

Table 9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	290	K/W
			[2] _	-	170	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[3] _	-	35	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- Soldering point of cathode tab.

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Characteristics 7.

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Table 10. Characteristics

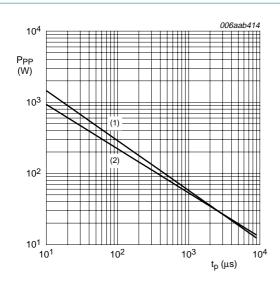
T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	ľ	V lin	Тур	Max	Unit
V_{RWM}	reverse standoff voltage						
	PESD5V0S1UJ		-		-	5	V
	PESD12VS1UJ		-		-	12	V
I _{RM}	reverse leakage current						
	PESD5V0S1UJ	$V_{RWM} = 5 V$	-		0.3	4	μΑ
	PESD12VS1UJ	$V_{RWM} = 12 V$	-		< 1	100	nΑ
V_{BR}	breakdown voltage	$I_R = 5 \text{ mA}$					
	PESD5V0S1UJ		6	6.2	6.8	7.3	V
	PESD12VS1UJ		1	13.3	14.5	15.75	V
C _d	diode capacitance	f = 1 MHz; $V_R = 0 V$					
	PESD5V0S1UJ		-		480	530	pF
	PESD12VS1UJ		-		160	180	pF
V _{CL}	clamping voltage		<u>[1]</u>				
	PESD5V0S1UJ	$I_{PP} = 47 \text{ A}$	-		-	19	V
		$I_{PP} = 25 \text{ A}$	-		-	13.5	V
		$I_{PP} = 5 A$	-		-	9.8	V
	PESD12VS1UJ	$I_{PP} = 22.5 \text{ A}$	-		-	27	V
		I _{PP} = 15 A	-		-	23.5	V
		$I_{PP} = 5 A$	-		-	19	V
r _{dif}	differential resistance	$I_R = 5 \text{ mA}$					
	PESD5V0S1UJ		-		2	100	Ω
	PESD12VS1UJ		-		5	100	Ω

^[1] Non-repetitive current pulse 8/20 µs exponential decay waveform according to IEC 61000-4-5.

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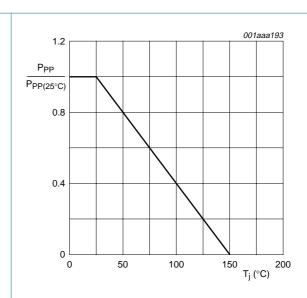
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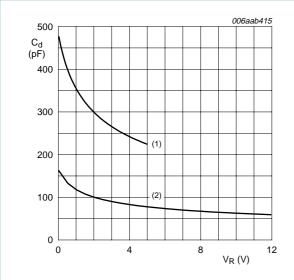
 $T_{amb} = 25 \, ^{\circ}C$

- (1) PESD5V0S1UJ
- (2) PESD12VS1UJ

Peak pulse power as a function of exponential Fig 3. pulse duration; typical values



Relative variation of peak pulse power as a Fig 4. function of junction temperature; typical values

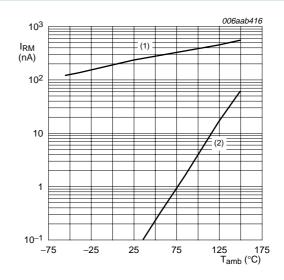


 $f = 1 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}$

- (1) PESD5V0S1UJ
- (2) PESD12VS1UJ

Product data sheet

Diode capacitance as a function of reverse Fig 5. voltage; typical values



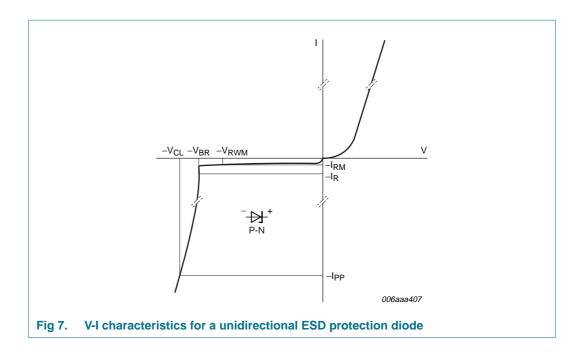
- (1) PESD5V0S1UJ
- (2) PESD12VS1UJ

Reverse leakage current as a function of Fig 6. ambient temperature; typical values

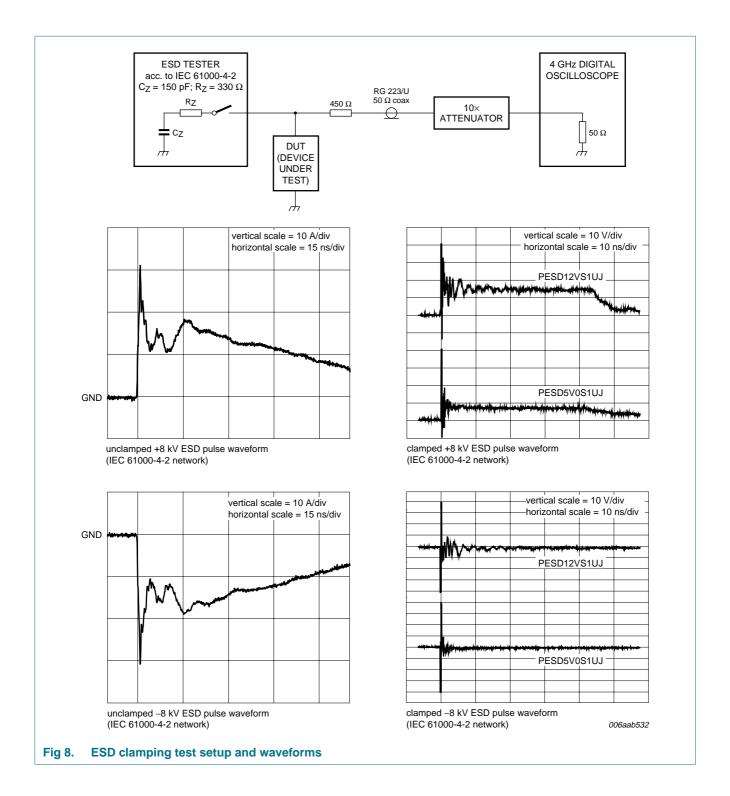
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Unidirectional ESD protection for transient voltage suppression



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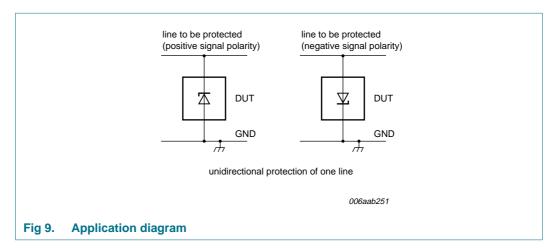


Unidirectional ESD protection for transient voltage suppression

8. Application information

PESD5V0S1UJ and PESD12VS1UJ are designed for the protection of one unidirectional data or signal line from the damage caused by ESD and transient overvoltage. The devices may be used on lines where the signal polarities are either positive or negative with respect to ground.

The PESD5V0S1UJ provides a surge capability of 890 W and the PESD12VS1UJ provides a surge capability of 600 W per line for an 8/20 µs waveform.



Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD and Electrical Fast Transient (EFT). The following guidelines are recommended:

- 1. Place the device as close to the input terminal or connector as possible.
- 2. The path length between the device and the protected line should be minimized.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

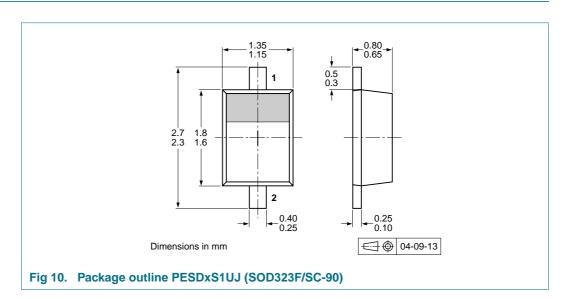
Unidirectional ESD protection for transient voltage suppression

Test information

9.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

10. Package outline



11. Packing information

Product data sheet

Table 11. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity	
			3000	10000
PESD5V0S1UJ	SOD323F	4 mm pitch, 8 mm tape and reel	-115	-135
PESD12VS1UJ				

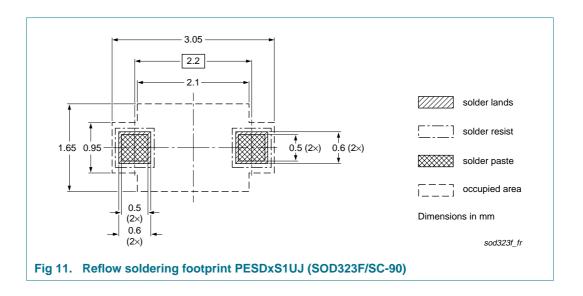
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[1] For further information and the availability of packing methods, see Section 15.

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12. Soldering



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13. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PESD5V0S1UJ_PESD12VS1UJ_1	20090603	Product data sheet	-	-

Unidirectional ESD protection for transient voltage suppression

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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NXP Semiconductors

PESD5V0S1UJ; PESD12VS1UJ

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Date of release: 3 June 2009
Document identifier: PESD5V0S1UJ_PESD12VS1UJ_1



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